

BY448GP

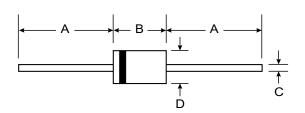
2.0A Axial Leaded Sintered Class Junction Plastic Rectifier

Features

- High temperature metallurgically bonded construction
- Sintered glass cavity free junction
- Capability of meeting environmental standard of MIL-S-19500
- High temperature soldering guaranteed 350°C /10sec/0.375"lead length at 5 lbs tension
- Operate at Ta =55°C with no thermal run away
- Typical Ir<0.1μA

Mechanical Data

- Terminal:Plated axial leads solderable per MIL-STD 202E, method 208C
- Case:Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
- Polarity:color band denotes cathode
- Mounting position:any



| DO-15 | | | | |
|----------------------|---------|-------|--|--|
| Dim | Min Max | | | |
| Α | 25.40 | _ | | |
| В | 5.50 | 7.62 | | |
| С | 0.686 | 0.889 | | |
| D | 2.60 | 3.60 | | |
| All Dimensions in mm | | | | |

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| | | SYMBOL | BY448GP | units |
|---|-----------------------|----------|--------------|----------|
| Maximum Recurrent Peak Reverse Voltage | je | Vrrm | 1650 | V |
| Maximum RMS Voltage | | Vrms | 1150 | V |
| Maximum DC blocking Voltage | | Vdc | 1650 | V |
| Maximum Average Forward Rectified Current 3/8"lead length at Ta =55°C | | If(av) | 2.0 | А |
| Peak Forward Surge Current 8.3ms single Half sine-wave superimposed on rated load | | Ifsm | 30.0 | А |
| Maximum Instantaneous Forward Voltage at 3.0A | | Vf | 1.60 | V |
| Maximum full load reverse current full cyc Average at 55°C | e | Ir(av) | 100.0 | μΑ |
| Maximum DC Reverse Current at rated DC blocking voltage | Ta =25°C Ta =150°C | Ir | 5.0 150.0 | μA μA |
| Typical Reverse Recovery Time | (Note 1) | Trr | 1000 | nS |
| Typical Thermal Resistance | (Note 2) | Rth(ja) | 100 | K/W |
| Storage and Operating Junction Tempera | ture | Tstg, Tj | -65 to +175 | °C |

Note:

- 1. Reverse Recovery Condition If =0.5A, Ir =1.0A, Irr =0.25A
- 2. Thermal Resistance from Junction to Ambient on PC board with spacing 25mm



